



Product Change Notification

106686 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 106686 - 00
Change Title: SC5400, PCN 106686-00, Product Design, Class 2, Fab Change on Front Panel board
Date of Publication: August 14, 2006

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 18, 2006
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Description of Change to the Customer:

Fab change on front panel board to embed the thermal sensor wire added in PCN 106427-00.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers

Products Affected / Intel Ordering Codes:

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA	Pre-Change Subassembly	Post-Change Subassembly
ARIG2PMKIT	878328	878328	D33872-002	D33872-003	D23493-303	D23493-401
SC5400BASE	877757	877757	D33731-002	D33731-003	D23493-303	D23493-401
SC5400BASENA	881189	881189	D33731-002	D33731-003	D23493-303	D23493-401
SC5400BRP	877804	877804	D33733-002	D33733-003	D23493-303	D23493-401
SC5400BRPNA	880615	880615	D33733-002	D33733-003	D23493-303	D23493-401
SC5400LX	877844	877844	D33732-002	D33732-003	D23493-303	D23493-401
SC5400LXNA	880322	880322	D33732-002	D33732-003	D23493-303	D23493-401

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

August 14, 2006

Revision Number:

00

Reason:

Originally Published PCN